## 502721746 03/14/2014

# **PATENT ASSIGNMENT COVER SHEET**

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT2768350

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
TEPPEI KIMURA	03/04/2014

#### **RECEIVING PARTY DATA**

Name:	JAPAN ELECTRONIC MATERIALS CORPORATION	
Street Address:	2-5-13 NISHINAGASU-CHO	
City:	AMAGASAKI-SHI, HYOGO	
State/Country:	JAPAN	
Postal Code:	660-0805	

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14206896

#### **CORRESPONDENCE DATA**

**Fax Number:** (703)385-9719

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via

US Mail.

**Phone:** 703-385-9688

Email: lbowersox@kbpatentlaw.com
Correspondent Name: KILYK & BOWERSOX, P.L.L.C.

Address Line 1: 3925 CHAIN BRIDGE ROAD, SUITE D-401

Address Line 4: FAIRFAX, VIRGINIA 22030

ATTORNEY DOCKET NUMBER:	5150-016
NAME OF SUBMITTER:	LEONARD D. BOWERSOX
SIGNATURE:	/Leonard D. Bowersox/
DATE SIGNED:	03/14/2014

**Total Attachments: 1** 

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PATENT 502721746 REEL: 032436 FRAME: 0965

# **ASSIGNMENT**

JOINT INVENTION

(Worldwide Rights)

WHEREAS I, the below named inventor [hereinafter referred to as Assignor], have made an invention entitled: GUIDE PLATE FOR PROBE CARD, for which I filed an application for United States Letters Patent on March 12, 2014, as Application No. 14/206, 896 (the Assignee being hereby authorized to insert the filing date and Patent Application No. when ascertained); and

WHEREAS, <u>JAPAN ELECTRONIC MATERIALS CORPORATION</u>, a corporation of <u>Japan</u>, [hereinafter referred to as Assignee], whose post office address is <u>2-5-13 Nishinagasu-cho</u>, <u>Amagasaki-shi</u>, <u>Hyogo 660-0805</u>, <u>Japan</u>, is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I, as assignor, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, my entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such application, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I HEREBY covenant that I have the full right to convey the interest assigned by this Assignment, and I have not executed and will not execute any agreement in conflict with this Assignment;

AND, I HEREBY further covenant and agree that I will, without further consideration, communicate with assignee, its successors and assigns, any facts known to me respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths, and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

FULL NAME OF FIRST INVENTOR: Teppei KIMURA	A CONTRACTOR OF THE CONTRACTOR			
Address: c/o 2-5-13 Nishinagasu-cho, Amagasaki-shi, Hyogo 660-0805, Japan				
Signature: Teppei Kimura	1.			
Date: Mar. 4. 2014				